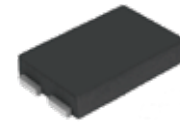


FEATURES

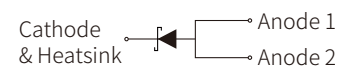
- Low Leakage Current
- High Efficiency
- Heatsink Design
- Halogen-Free According To IEC 61249-2-21 Definition
- Moisture Sensitivity: Level 1, Per J-STD-020
- Low Forward Voltage Drop



TO-277B



Marking



Schematic Symbol

MECHANICAL DATA

- Case: TO-277B
- Molding Compound Meets UL 94V-0 Flammability
- Terminals: Matte Tin Plated Leads, Solderable Per J-STD-002 And JESD 22-B102

APPROVALS

RoHS	Compliance with 2011/65/EU
HF	Compliance with IEC61249-2-21:2003

MAXIMUM RATINGS ($T_A=25^{\circ}\text{C}$)

Parameter	Symbol	Value	Unit
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	60	V
Maximum RMS Voltage	V_{RMS}	42	V
Maximum DC Blocking Voltage	V_{DS}	60	V
Maximum Average Forward Rectified Current	$I_{F(AV)}$	10	A
	$I_{F(AV)}^{(1)}$	5	A
Peak Forward Surge Current 8.3 ms Single Half Sine-Wave Superimposed On Rated Load	$I_{FSM}^{(2)}$	150	A
Operating Junction And Storage Temperature Range	T_J, T_{STG}	-55 to 150	$^{\circ}\text{C}$

ELECTRICAL CHARACTERISTICS($T_A=25^{\circ}\text{C}$)

Parameter	Symbol	Test Conditions		Min.	Typ.	Max.	Unit
Maximum Instantaneous Forward Voltage	V_F	$I_F=10\text{A}$	$T_A=25^{\circ}\text{C}$			0.55	Volts
Maximum DC Reverse Current at Rated DC Blocking Voltage	I_R	Rated V_R	$T_A=25^{\circ}\text{C}$			0.10	mA
			$T_A=100^{\circ}\text{C}$			40	
Typical Thermal Resistance ¹⁾	$R_{\theta JA}$	Juntion To Ambient				80	$^{\circ}\text{C/W}$
	$R_{\theta JC}$	Juntion To Case				35	
	$R_{\theta JM}$	Juntion To Mount				20	

Notes:

- 1) The Thermal Resistance From Junction To Ambient,case Or Mount,mounted On P.C.B With $30 \times 30\text{mm}$ Copper Pads,2 oz,FR4 PCB.
- 2) Mounted On Recommended Copper Pad Area,free Air.

CHARACTERISTIC CURVES

Fig.1 Forward Current Derating Curve

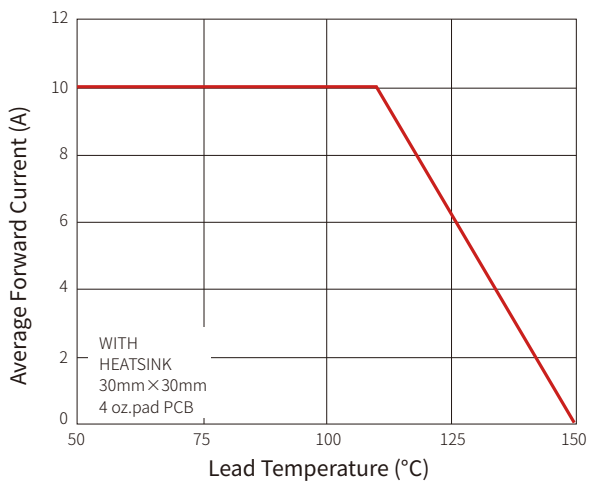


Fig.2 Typical Forward Characteristics

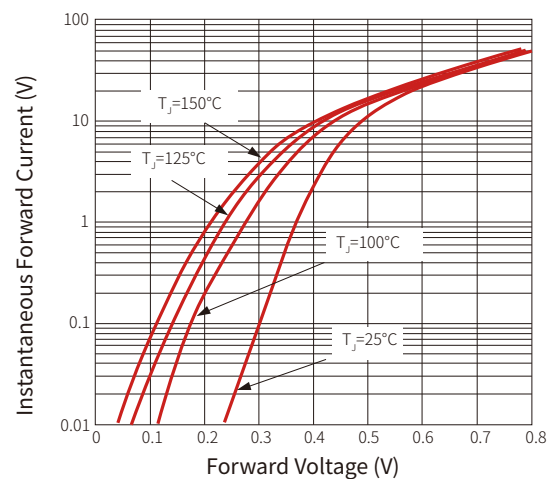
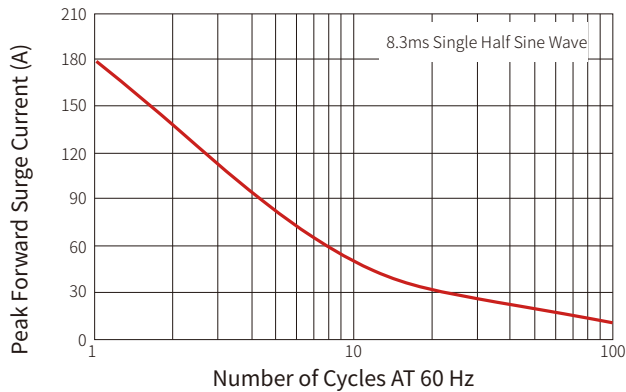
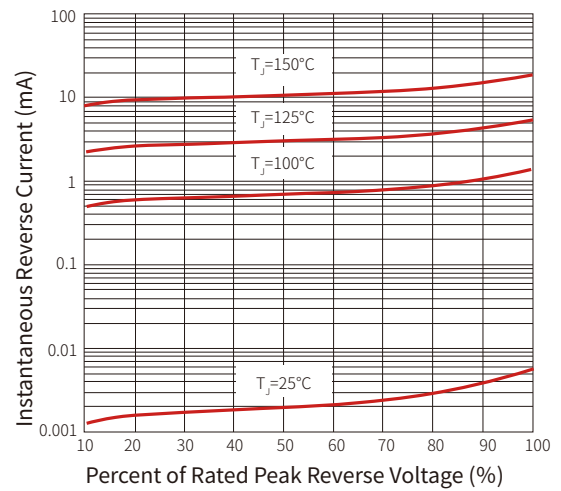
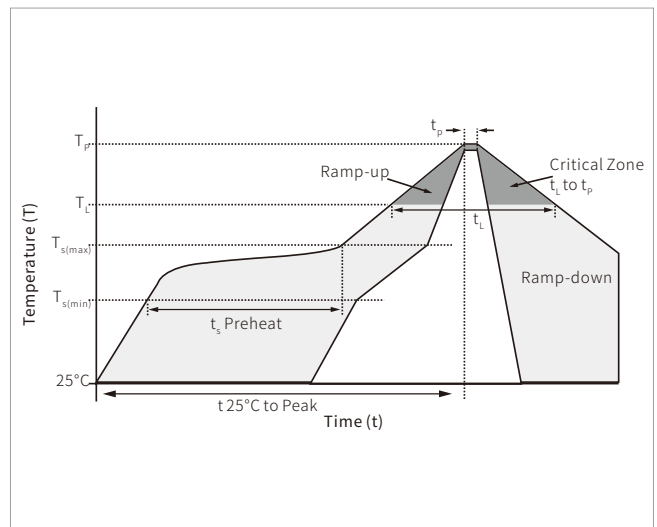


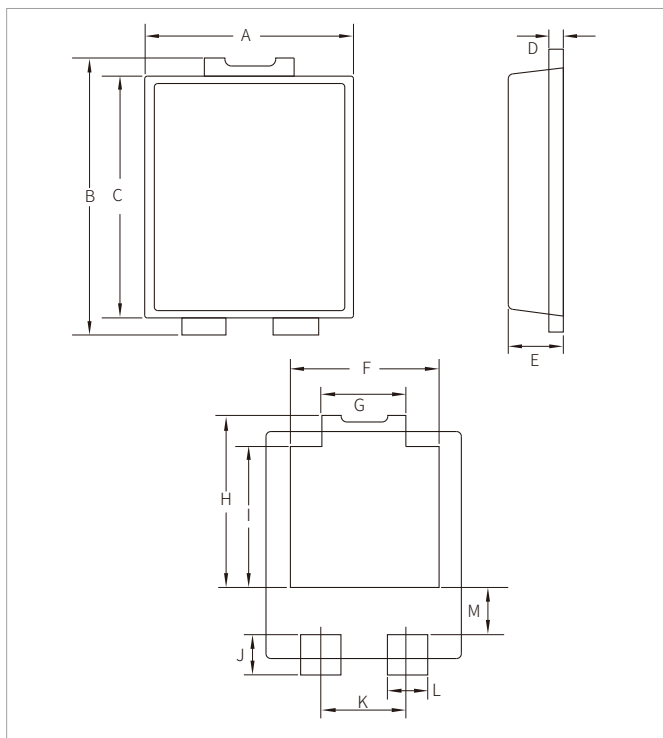
Fig.3 Maximum Non-Repetitive Peak Forward Surge Current

Fig.4 Typical Reverse Characteristics


SOLDERING PARAMETERS

Reflow Condition		Lead-free assembly
Pre Heat	Temperature Max ($T_{s(\min)}$)	150°C
	Temperature Max ($T_{s(\max)}$)	200°C
	Time (min to max) (t_s)	60 – 180 secs
Average ramp up rate (Liquidus Temp (T_L) to peak		3°C/second max
$T_{s(\max)}$ to T_L - Ramp-up Rate		3°C/second max
Reflow	Temperature (T_L) (Liquidus)	217°C
	Time (min to max) (t_L)	60 – 150 seconds
Peak Temperature (T_p)		260°C
Time within 5°C of actual peak Temperature (t_p)		20 – 40 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature (T_p)		8 minutes max.
Do not exceed		260°C

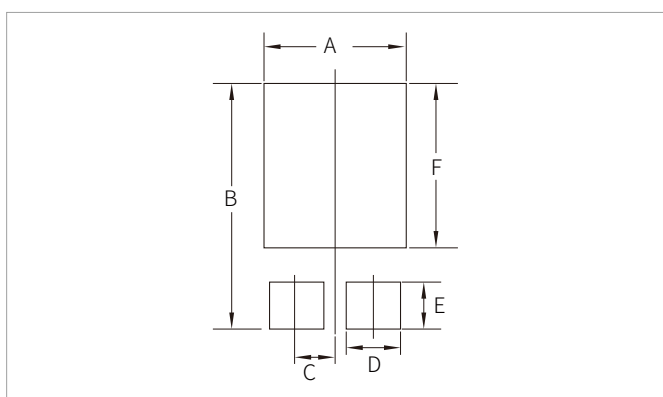


TO-277B PACKAGE INFORMATION



Ref.	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	4.00	4.60	0.157	0.181
B	6.20	6.80	0.244	0.268
C	5.50	6.00	0.216	0.236
D	0.25	0.40	0.010	0.016
E	1.05	1.35	0.041	0.053
F	3.00	3.50	0.118	0.138
G	1.70	2.00	0.067	0.079
H	4.20	4.50	0.165	0.177
I	3.52Nom		0.139Nom	
J	0.85	1.10	0.033	0.043
K	1.86Nom		0.073Nom	
L	0.80	1.00	0.031	0.039
M	1.10	1.40	0.043	0.055

RECOMMENDED PAD LAYOUT DIMENSIONS



Ref.	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	3.40	-	0.134	-
B	6.90		0.272	
C	0.95		0.037	
D	1.30	-	0.051	-
E	1.30	-	0.051	-
F	4.60	-	0.181	-

ORDERING INFORMATION

Part Number	Component Package	Marking	QTY/Reel	Reel Size
TSP1060L	TO-277B	TSP1060	5000PCS	13"

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By QR Code

Website



Wechat

To find your local partner within Semiware's global website: www.semiware.com

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